

Advance GTVA101K42EV

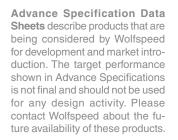
Thermally-Enhanced High Power RF GaN on SiC HEMT 1400 W, 50 V, 960 - 1215 MHz

Description

The GTVA101K42EV is a 1400-watt GaN on SiC high electron mobility transistor (HEMT) for use in multi-standard cellular power amplifier applications. It features input matching, high efficiency, and a thermally-enhanced surface-mount package with bolt-down flange.

Features

- GaN on SiC HEMT technology
- Input matched
- Typical Pulsed CW performance, 960 1215 MHz, 50 V, single side, 128 µs pulse width, 10% duty cycle
 - Output power at P_{3dB} = 1400 W
 - Efficiency = 68%
 - Gain = 17 dB
- Pb-free and RoHS compliant





GTVA101K42EV Package H-36275-4

Target RF Characteristics

Pulsed CW Specifications (tested in Wolfspeed test fixture) V_{DD} = 50 V, I_{DQ} = 200 mA, P_{OUT (P3dB)} = 1400 W peak, f = 960 to 1215 MHz, pulse width = 128 µs, 10% duty cycle

| Characteristic | Symbol | Min | Тур | Max | Unit |
|------------------|-----------------|-----|-----|-----|------|
| Linear Gain | G _{ps} | _ | 17 | _ | dB |
| Drain Efficiency | η_D | _ | 68 | _ | % |

All published data at $T_{CASE} = 25^{\circ}C$ unless otherwise indicated

ESD: Electrostatic discharge sensitive device—observe handling precautions!

DDC Characteristics

| Characteristic Conditions | | Symbol | Min | Тур | Max | Unit |
|--------------------------------|---|----------------------|------|------|------|------|
| Drain-source Breakdown Voltage | V_{GS} = -8 V, I _D = 100 mA | V _{(BR)DSS} | 150 | — | — | V |
| Drain-source Leakage Current | $V_{GS} = -8$ V, $V_{DS} = 10$ V | I _{DSS} | _ | _ | 5 | mA |
| Gate Threshold Voltage | $V_{DS} = 10 \text{ V}, \text{ I}_{D} = 200 \text{ mA}$ | V _{GS(th)} | -3.8 | -3.0 | -2.7 | V |

Recommended Operating Conditions

| Parameter | Conditions | Symbol | Min | Тур | Max | Unit |
|-------------------------|---|--------------------|-----|------|-----|------|
| Drain Operating Voltage | | V _{DD} | 0 | — | 55 | V |
| Gate Quiescent Voltage | $V_{DS} = 50 \text{ V}, \text{ I}_{D} = 200 \text{ mA}$ | V _{GS(Q)} | _ | -3.1 | _ | V |

Absolute Maximum Ratings

| Parameter | Symbol | Value | Unit |
|---------------------------|------------------|-------------|------|
| Drain-source Voltage | V _{DSS} | 125 | V |
| Gate-source Voltage | V _{GS} | -10 to +2 | V |
| Gate Current | I _G | TBD | mA |
| Drain Current | ۱ _D | TBD | А |
| Junction Temperature | TJ | 225 | °C |
| Storage Temperature Range | T _{STG} | -65 to +150 | °C |

Operation above the maximum values listed here may cause permanent damage. Maximum ratings are absolute ratings; exceeding only one of these values may cause irreversible damage to the component. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. For reliable continuous operation, the device should be operated within the operating voltage range (V_{DD}) specified above.

Thermal Chracteristics

| Parameter | Symbol | Value | Unit |
|--------------------------------------|---------------------|-------|------|
| Thermal Resistance, Junction to Case | $R_{	ext{	heta}JC}$ | TBD | °C/W |

Ordering Information

| Type and Version | Order Code | Package Description | Shipping |
|--------------------|------------|----------------------|----------------------|
| GTVA101K42EV V1 R0 | TBD | H-36275-4, bolt-down | Tape & Reel, 50 pcs |
| GTVA101K42EV V1 R2 | TBD | H-36275-4, bolt-down | Tape & Reel, 250 pcs |

Evaluation Boards

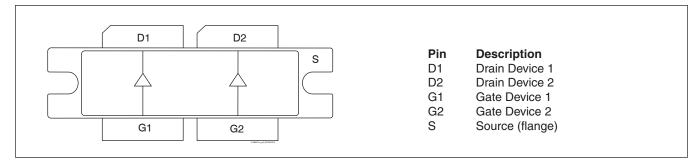
| Order Code Frequency | | Description | | |
|----------------------|----------------|--|--|--|
| LTN/GTVA101K42EV E1 | 960 – 1215 MHz | Class AB, combined outputs, RO4350B, 0.508mm thick | | |
| LTN/GTVA101K42EV E2 | 1030 MHz | Class AB, combined outputs, RO4350B, 0.508mm thick | | |

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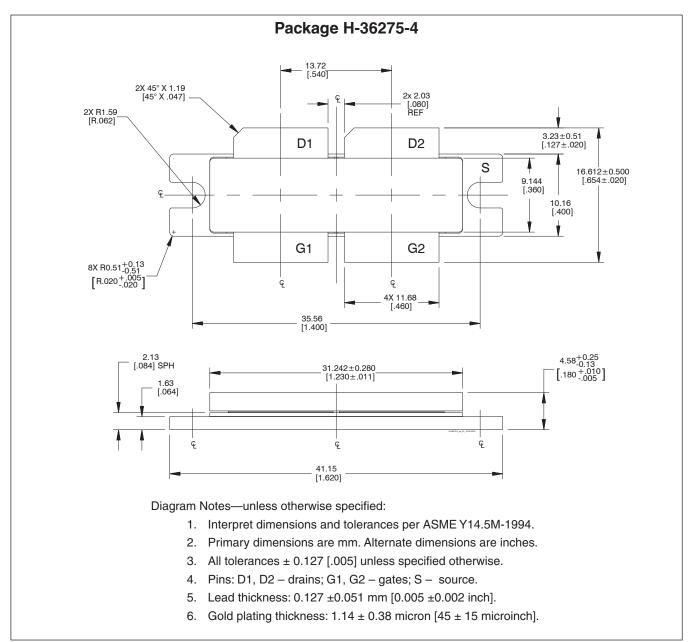


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Pinout Diagram (top view)



Package Outline Specifications



Advance GTVA101K42EV

Revision History

| Revision | Date | Data Sheet Type | Page | Subjects (major changes since last revision) |
|----------|------------|-----------------|-----------|--|
| 01 | 2016-10-13 | Advance | All | Data Sheet reflects advance specification for product development |
| 01.1 | 2017-07-31 | Advance | 2 | Added evaluation boards information |
| 02 | 2018-05-01 | Advance | All, 2, 3 | Converted to Wolfspeed Data Sheet, updated DC characteristics and max ratings table format, added pinout diagram |

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Notes

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